TOSHIBA Photocoupler IRED & Photo-Diode Array

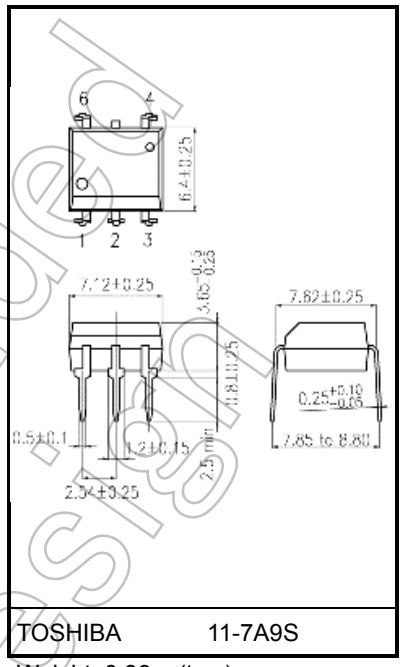
TLP591B

Telecommunications
Programmable Controllers
MOS Gate Drivers
MOSFET Gate Drivers

The TOSHIBA TLP591B consists of an infrared emitting diode optically coupled to a series-connected photo-diode array in a six-lead plastic DIP package.
The TLP591B is suitable for MOS FET gate drivers.
The TLP591B has an internal shunt resistor to optimize switching speed.

- UL-recognized: UL 1577, File No.E67349

Unit: mm



TOSHIBA 11-7A9S

Weight: 0.39 g (typ.)

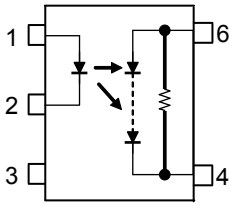
Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit
LED	Forward current	I_F	50	mA
	Forward current derating (Ta ≥ 25°C)	ΔI_F /°C	-0.5	mA /°C
	Pulse forward current (100 μs pulse, 100 pps)	I_{FP}	1	A
	Reverse voltage	V_R	3	V
	Diode power dissipation	P_D	100	mW
	Diode power dissipation derating (Ta ≥25°C)	ΔP_D /°C	-1.0	mW/°C
	Junction temperature	T_j	125	°C
Detector	Forward current	I_{FD}	50	μA
	Reverse voltage	V_{RD}	10	V
	Output power dissipation	P_O	0.5	mW
	Junction temperature	T_j	125	°C
Storage temperature range		T_{stg}	-55 to 125	°C
Operating temperature range		T_{opr}	-40 to 85	°C
Lead soldering temperature (10 s)		T_{sol}	260	°C
Isolation voltage (AC, 60 s, R.H. ≤ 60 %) (Note 1)		BV_S	2500	V_{rms}

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook (“Handling Precautions”/“Derating Concept and Methods”) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Device considered a two terminal device: Pins 1, 2 and 3 shorted together, and pins 4 and 6 shorted together.

Pin Configuration (top view)



1. : Anode(LED)
2. : Cathode(LED)
3. : NC
4. : Cathode
6. : Anode

Start of commercial production
1990-11

Recommended Operating Conditions

Characteristic	Symbol	Min	Typ.	Max	Unit
Forward current	I_F	—	20	25	mA
Operating temperature	T_{opr}	-25	—	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Electrical Characteristics (Ta = 25°C)

	Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
LED	Forward voltage	V_F	I_F = 10 mA	1.2	1.4	1.7	V
	Reverse current	I_R	V_R = 3 V	—	—	10	μA
	Capacitance	C_T	V = 0 V, f = 1 MHz	—	30	60	pF
Detector	Forward voltage	V_{FD}	I_{FD} = 10 μA	—	7	—	V
	Reverse current	I_{RD}	V_{RD} = 10 V	—	7	—	μA

Coupled Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Open voltage	V_{OC}	I_F = 20 mA	7	8	—	V
Short Current	I_{SC}	I_F = 20 mA	24	40	—	μA

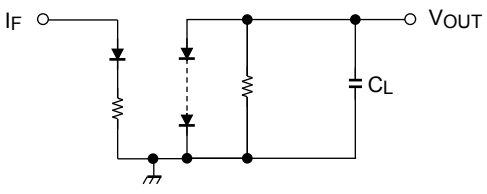
Isolation Characteristics (Ta = 25°C)

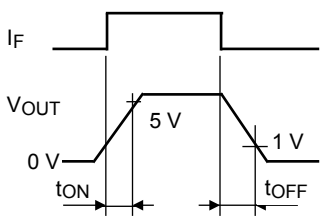
Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Capacitance (input to output)	C_S	V_S = 0 V, f = 1 MHz	—	0.8	—	pF
Isolation resistance	R_S	V_S = 500 V, R.H. ≤ 60 %	5×10^{10}	10^{14}	—	Ω
Isolation voltage	BV_S	AC, 60 s	2500	—	—	Vrms

Switching Characteristics (Ta = 25°C)

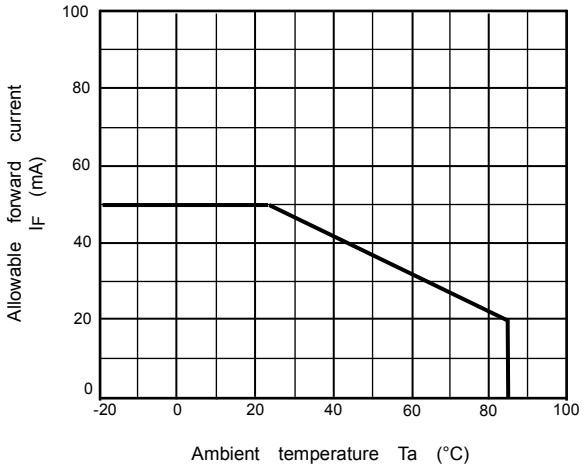
Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Turn-on time	t_{ON}	I_F = 20 mA, C_L = 1000 pF (Note 2)	—	0.2	—	ms
Turn-off time	t_{OFF}		—	3	—	ms

Note 2: Switching time test circuit

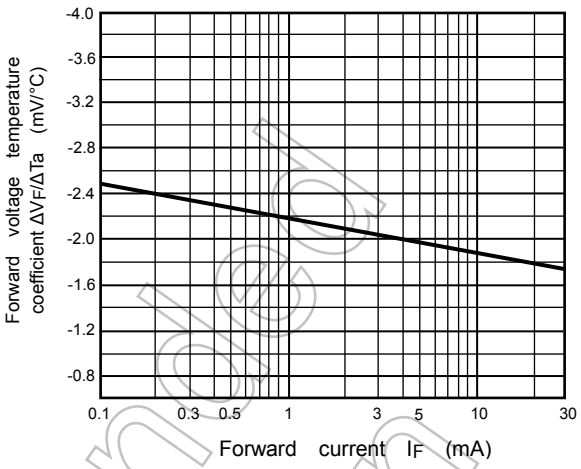




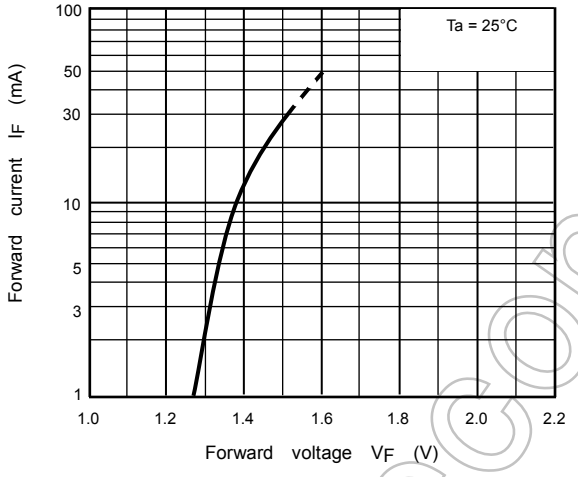
I_F – Ta



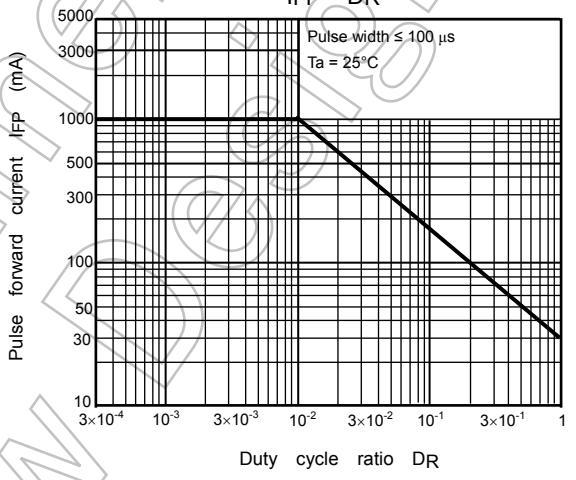
$\Delta V_F/\Delta Ta$ – I_F



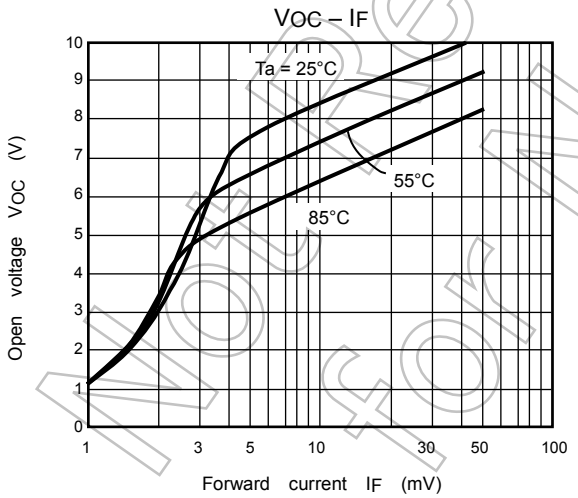
I_F – V_F



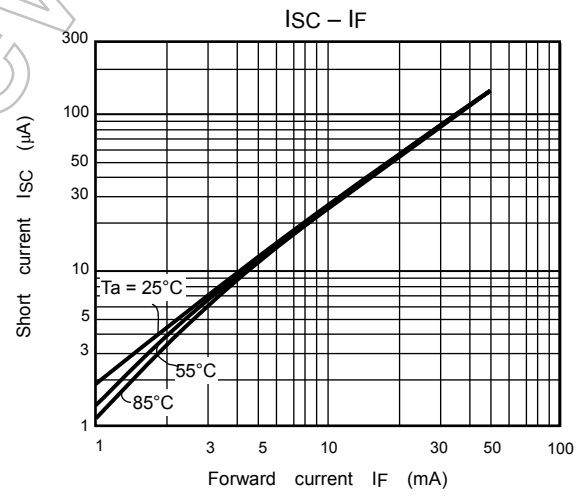
I_{FP} – D_R



V_{OC} – I_F



I_{SC} – I_F



NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

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